

Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Currently Amended) A semiconductor device comprising:
a substrate;
a first insulating film provided over said substrate;
a second insulating film provided over said first insulating film;
a semiconductor film provided over ~~a substrate~~ said second insulating film; ~~and~~
a source region and a drain region provided in said semiconductor film;
a channel region provided in said semiconductor film between said source region and
said drain region; and
a gate electrode provided over said ~~semiconductor film~~ channel region with a gate insulating film therebetween,
wherein said gate insulating film comprises an organic resin, and
wherein an impurity concentration in an interface between said first insulating film
and said second insulating film is higher than an impurity concentration in an interface
between said second insulating film and said channel region.
2. (Original) A device according to claim 1 wherein said semiconductor device is incorporated into one selected from the group consisting of a personal computer, a video camera, a mobile computer, a goggle type display, a player using a recording medium, a digital camera, a cellular phone, and an electronic book.
3. (Original) A device according to claim 1 wherein said semiconductor film comprises a material selected from the group consisting of silicon, germanium and $\text{Si}_x\text{Ge}_{1-x}$ where $0 < x < 1$.

4. (Original) A device according to claim 1 wherein said semiconductor film comprises a crystalline semiconductor.

5. (Original) A device according to claim 1 wherein said substrate is selected from the group consisting of an insulating substrate, a ceramic substrate, a stainless steel substrate, a metal substrate, a semiconductor substrate and a plastic substrate.

6. (Currently Amended) A device according to claim 1 wherein said organic resin comprises benzocyclobutene (BCB) ~~BCB~~.

7. (Currently Amended) A semiconductor device comprising:
a substrate;
a first insulating film provided over said substrate;
a second insulating film provided over said first insulating film;
a semiconductor film provided over ~~a substrate~~ said second insulating film;
a channel region provided in said semiconductor film; and
a gate electrode provided over said channel region with a gate insulating film therebetween,
wherein said gate insulating film comprises an organic resin, and
wherein an impurity concentration in an interface between said first insulating film and said second insulating film is higher than an impurity concentration in an interface between said second insulating film and said channel region.

8. (Original) A device according to claim 7 wherein said semiconductor device is incorporated into one selected from the group consisting of a personal computer, a video camera, a mobile computer, a goggle type display, a player using a recording medium, a digital camera, a cellular phone, and an electronic book.

9. (Original) A device according to claim 7 wherein said semiconductor film comprises a material selected from the group consisting of silicon, germanium and $\text{Si}_x\text{Ge}_{1-x}$ where $0 < x < 1$.

10. (Original) A device according to claim 7 wherein said semiconductor film comprises a crystalline semiconductor.

11. (Original) A device according to claim 7 wherein said substrate is selected from the group consisting of an insulating substrate, a ceramic substrate, a stainless steel substrate, a metal substrate, a semiconductor substrate and a plastic substrate.

12. (Currently Amended) A device according to claim 7 wherein said organic resin comprises benzocyclobutene (BCB) ~~BCB~~.

13. (New) A device according to claim 1 wherein said second insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.

14. (New) A device according to claim 1 wherein said first insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.

15. (New) A device according to claim 7 wherein said second insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.

16. (New) A device according to claim 7 wherein said first insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.

17. (New) A semiconductor device comprising:
a substrate;
a first insulating film provided over said substrate;
a second insulating film provided over said first insulating film;

a semiconductor film provided over said second insulating film;
a channel region provided in said semiconductor film; and a gate electrode provided over said channel region with a gate insulating film therebetween,
wherein said gate insulating film comprises an organic resin,
wherein an impurity concentration in an interface between said first insulating film and said second insulating film is higher than an impurity concentration in an interface between said second insulating film and said channel region, and
wherein said second insulating film is thinner than said first insulating film.

18. (New) A device according to claim 17 wherein said semiconductor device is incorporated into one selected from the group consisting of a personal computer, a video camera, a mobile computer, a goggle type display, a player using a recording medium, a digital camera, a cellular phone, and an electronic book.

19. (New) A device according to claim 17 wherein said semiconductor film comprises a material selected from the group consisting of silicon, germanium and $\text{Si}_x\text{Ge}_{1-x}$ where $0 < x < 1$.

20. (New) A device according to claim 17 wherein said semiconductor film comprises a crystalline semiconductor.

21. (New) A device according to claim 17 wherein said substrate is selected from the group consisting of an insulating substrate,
a ceramic substrate, a stainless steel substrate, a metal substrate, a semiconductor substrate and a plastic substrate.

22. (New) A device according to claim 17 wherein said organic resin comprises benzocyclobutene.

23. (New) A device according to claim 17 wherein said second insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.

24. (New) A device according to claim 17 wherein said first insulating film comprises a material selected from the group consisting of silicon nitride, silicon oxynitride and silicon oxide.